

DATA SHEET

CBT16211

24-bit bus switch with 12-bit output enables

Product data

2001 Jun 13

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CBT16211

FEATURES

- 5 Ω switch connection between two ports
- TTL compatible control input levels
- Package options include plastic shrink small outline (SSOP), thin shrink small outline (TSSOP)
- ESD protection exceeds 1000 V CDM per JESD22-C101
- Latch-up testing is done to JESDEC Standard JESD78 which exceeds 100 mA

DESCRIPTION

The CBT16211 provides 24 bits of high-speed TTL-compatible bus switching. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The device is organized as a dual 12-bit bus switch with separate output-enable (\overline{OE}) inputs. It can be used as two 12-bit bus switches or as one 24-bit bus switch. When \overline{OE} is low, the associated 12-bit bus switch is on, and port A is connected to port B. When \overline{OE} is high, the switch is open, and a high-impedance state exists between the ports.

The CBT16211 is characterized for operation from -40 to 85 °C.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS $T_{amb} = 25$ °C; GND = 0 V	TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay An to Y_n	$C_L = 50$ pF; $V_{CC} = 5$ V	0.25	ns
C_{IN}	Input capacitance	$V_I = 0$ V or V_{CC}	4.3	pF
C_{OUT}	Output capacitance	Outputs disabled; $V_O = 0$ V or V_{CC}	6.9	pF
I_{CC}	Total supply current	Outputs disabled; $V_{CC} = 5.5$ V	3.0	μ A

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
56-Pin Plastic SSOP Type III	-40 to 85 °C	CBT16211DL	SOT371-1
56-Pin Plastic TSSOP Type II	-40 to 85 °C	CBT16211DGG	SOT364-1

FUNCTION TABLE

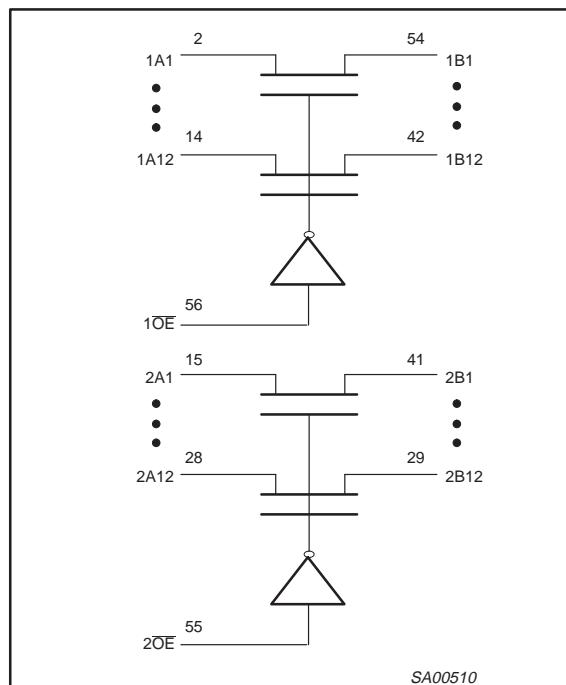
INPUTS		OUTPUTS	
1 \overline{OE}	2 \overline{OE}	1A, 1B	2A, 2B
L	L	1A = 1B	2A = 2B
L	H	1A = 1B	Z
H	L	Z	2A = 2B
H	H	Z	Z

H = High voltage level

L = Low voltage level

Z = High impedance "off" state

LOGIC SYMBOL



SA00510

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PIN CONFIGURATION

NC	1	56	1OE
1A1	2	55	2OE
1A2	3	54	1B1
1A3	4	53	1B2
1A4	5	52	1B3
1A5	6	51	1B4
1A6	7	50	1B5
GND	8	49	GND
1A7	9	48	1B6
1A8	10	47	1B7
1A9	11	46	1B8
1A10	12	45	1B9
1A11	13	44	1B10
1A12	14	43	1B11
2A1	15	42	1B12
2A2	16	41	2B1
V _{CC}	17	40	2B2
2A3	18	39	2B3
GND	19	38	GND
2A4	20	37	2B4
2A5	21	36	2B5
2A6	22	35	2B6
2A7	23	34	2B7
2A8	24	33	2B8
2A9	25	32	2B9
2A10	26	31	2B10
2A11	27	30	2B11
2A12	28	29	2B12

SA00509

PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	NC	No internal connection
56, 55	1OE, 2OE	Output Enables
2, 3, 4, 5, 6, 7, 9, 10, 11, 12, 13, 14	1A1-1A12	Inputs
54, 53, 52, 51, 50, 48, 47, 46, 45, 44, 43, 42	1B1-1B12	Outputs
15, 16, 18, 20, 21, 22, 23, 24, 25, 26, 27, 28	2A1-2A12	Inputs
41, 40, 39, 37, 36, 35, 34, 33, 32, 31, 30, 29	2B1-2B12	Outputs
8, 19, 38, 49	GND	Ground (0 V)
17	V _{CC}	Positive supply voltage

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ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		-0.5 to +7.0	V
I_{IK}	DC input diode current	$V_I < 0$	-50	mA
V_I	DC input voltage ³		-0.5 to +7.0	V
V_{OUT}	DC output voltage ³	output in Off or High state	-0.5 to +5.5	V
I_{OUT}	DC output current	output in Low state	128	mA
T_{Stg}	Storage temperature range		-65 to 150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.
3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		Min	Max	
V_{CC}	DC supply voltage	4.5	5.5	V
V_{IH}	High-level input voltage	2.0	—	V
V_{IL}	Low-level Input voltage	—	0.8	V
T_{amb}	Operating free-air temperature range	-40	+85	°C

DC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT	
			$T_{amb} = -40$ to +85 °C				
			Min	Typ ¹	Max		
V_{IK}	Input clamp voltage	$V_{CC} = 4.5$ V; $I_I = -18$ mA	—	—	-1.2	V	
V_P	Output high pass voltage	$V_{IN} = V_{CC} = 5.0$ V; $I_{OUT} = -100$ μ A	3.4	3.6	3.9	V	
I_I	Input leakage current	$V_{CC} = 0$ V; $V_I = 5.5$ V	—	—	10	μ A	
		$V_{CC} = 5.5$ V; $V_I = GND$ or 5.5 V	—	—	± 1		
I_{CC}	Quiescent supply current	$V_{CC} = 5.5$ V; $I_O = 0$, $V_I = V_{CC}$ or GND	—	—	3	μ A	
ΔI_{CC}	Additional supply current per input pin ²	$V_{CC} = 5.5$ V, one input at 3.4 V, other inputs at V_{CC} or GND	—	—	2.5	mA	
C_I	Control pins	$V_I = 3$ V or 0	—	4.5	—	pF	
$C_{I(OFF)}$	Port OFF capacitance	$V_O = 3$ V or 0, $\overline{OE} = V_{CC}$	—	6.9	—	pF	
r_{on}^3		$V_{CC} = 4.0$ V; $V_I = 2.4$ V; $I_I = 15$ mA	—	14	20	Ω	
		$V_{CC} = 4.5$ V; $V_I = 0$ V; $I_I = 64$ mA	—	5	7		
		$V_{CC} = 4.5$ V; $V_I = 0$ V; $I_I = 30$ mA	—	5	7		
		$V_{CC} = 4.5$ V; $V_I = 2.4$ V; $I_I = -15$ mA	—	8	12		

NOTES:

1. All typical values are at $V_{CC} = 5$ V, $T_{amb} = 25$ °C.
2. This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.
3. Measured by the voltage drop between the A and the B terminals at the indicated current through the switch.
On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

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AC CHARACTERISTICS

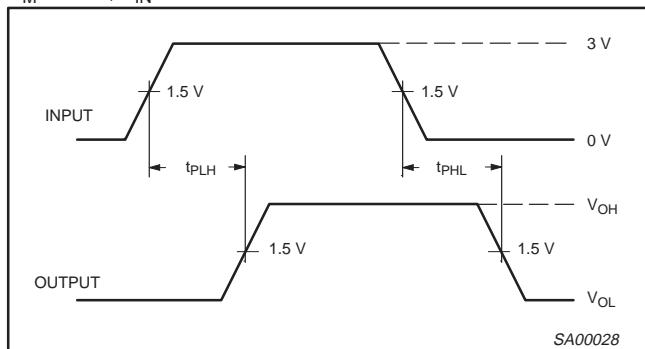
GND = 0 V; t_R ; C_L = 50 pF

SYMBOL	PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$		UNIT
				Min	Max	
t_{pd}	Propagation delay ¹	A or B	B or A	—	0.25	ns
t_{en}	Output enable time to High and Low level	\overline{OE}	A or B	1.5	6.0	ns
t_{dis}	Output disable time from High and Low level	\overline{OE}	A or B	1.5	6.0	ns

NOTE:

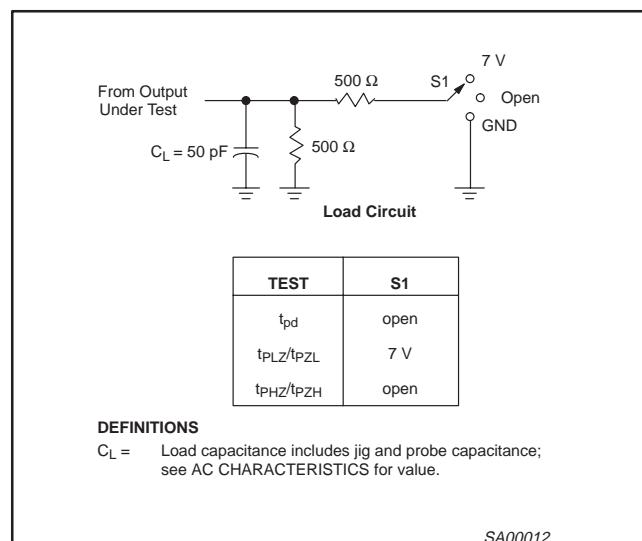
1. This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

AC WAVEFORMS

 $V_M = 1.5 \text{ V}$, $V_{IN} = \text{GND}$ to 3.0 V.

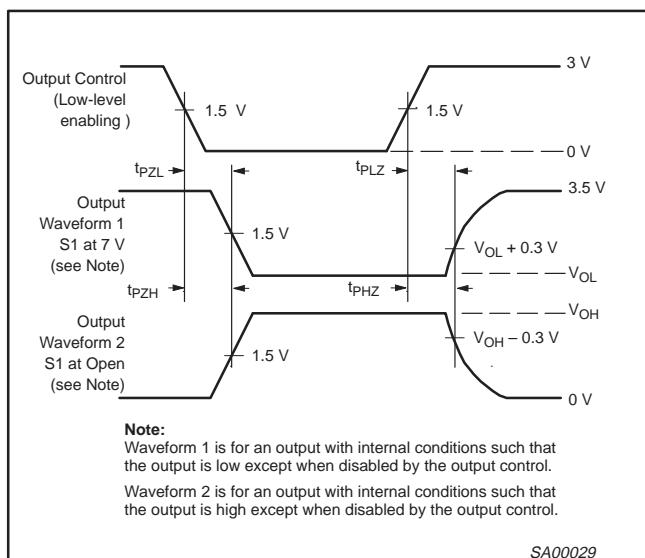
Waveform 1. Input (An) to Output (Yn) Propagation Delays

TEST CIRCUIT AND WAVEFORMS



DEFINITIONS

C_L = Load capacitance includes jig and probe capacitance;
see AC CHARACTERISTICS for value.



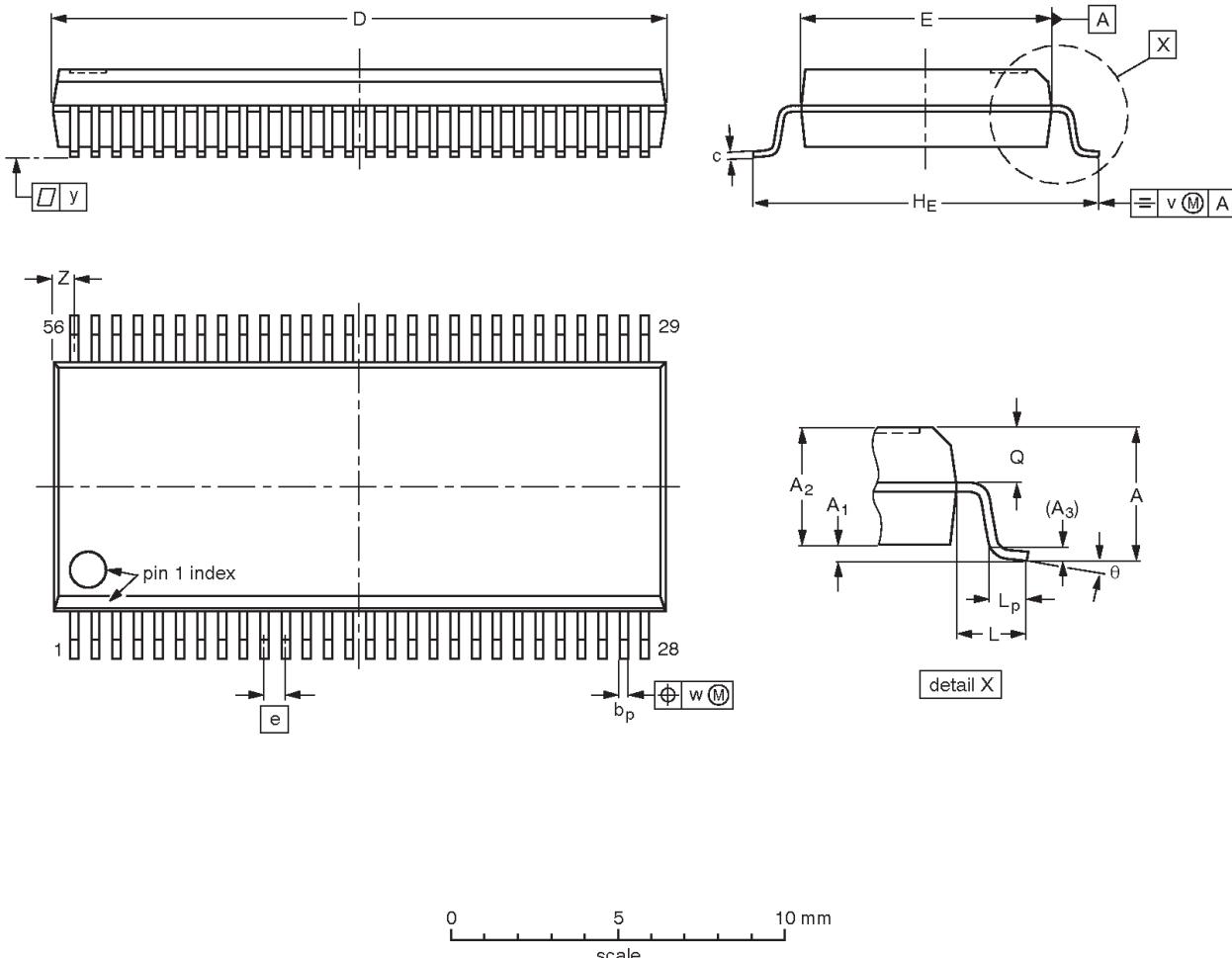
Waveform 2. 3-State Output Enable and Disable Times

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SSOP56: plastic shrink small outline package; 56 leads; body width 7.5 mm

SOT371-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	2.8 0.2	0.4 2.20	2.35	0.25	0.3 0.2	0.22 0.13	18.55 18.30	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

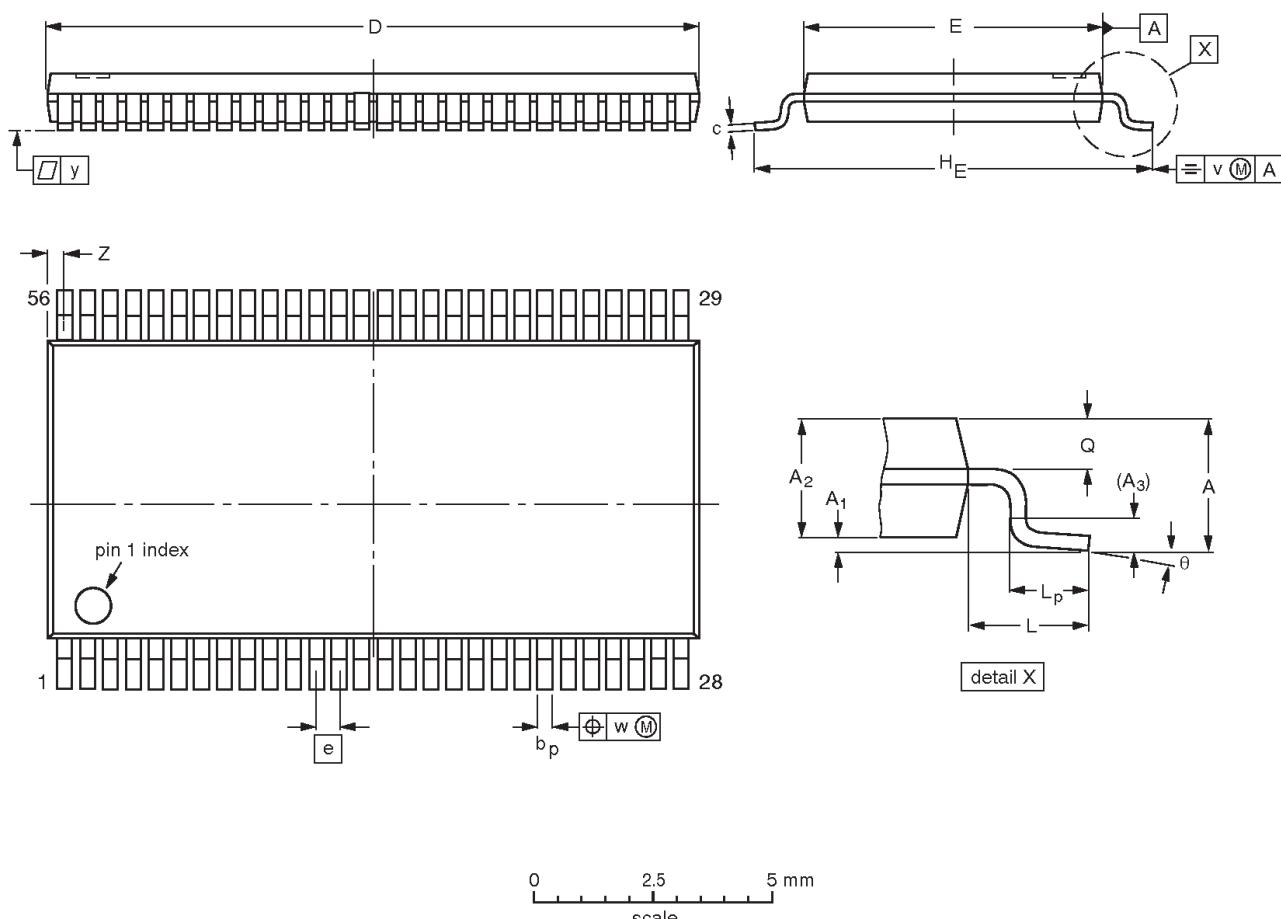
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT371-1		MO-118				95-02-04 99-12-27

24-bit bus switch with 12-bit output enables

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TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1



DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	Q	v	w	y	z	θ
mm	1.2 0.05	0.15 0.85	1.05	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1.0	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT364-1		MO-153				95-02-10 99-12-27

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Data sheet status ^[1]	Product status ^[2]	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Date of release: 06-01
Document order number: 9397 750 08481

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